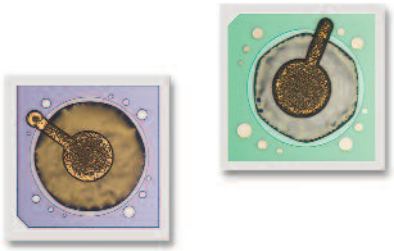
DATA SHEET

Silicon Schottky Diode Chips

Features

- For detector and mixer applications
- Low capacitance for usage beyond 40 GHz
- ZBD and low-barrier designs
- P-type and N-type junctions
- Large bond pad chip design
- Available lead (Pb)-free, RoHS-compliant, and Green



Description

Skyworks silicon Schottky diode chips are intended for use as detector and mixer devices in hybrid integrated circuits at frequencies from below 100 MHz to higher than 40 GHz. Skyworks “Universal Chip” design features a 4-mil-diameter bond pad that is offset from the semiconductor junction preventing damage to the active junction as a result of wire bonding.

As power-sensing detectors, these Schottky diode chips all have the same voltage sensitivity so long as the output video impedance is much higher than the video resistance of the diode. Figure 1 shows the expected detected voltage sensitivity as a function of RF source impedance in an untuned circuit. Note that sensitivity is substantially increased by transforming the source impedance from 50 Ω to higher values. Maximum sensitivity occurs when the source impedance equals the video resistance.

In a detector circuit operating at zero bias, depending on the video load impedance, a ZBD device with R_V less than 10 kΩ may be more sensitive than a low-barrier diode with R_V greater than 100 kΩ. Applying forward bias reduces the diode video resistance as shown in Figure 2. Lower video resistance also increases the video bandwidth but does not increase voltage sensitivity, as shown in Figure 3. Biased Schottky diodes have better temperature stability and also may be used in temperature compensated detector circuits.

P-type Schottky diodes generate lower 1/F noise and are preferred for Doppler mixers and biased detector applications. The bond pad for the P-type Schottky diode is the cathode. N-type Schottky diodes have lower parasitic resistance, R_S, and will perform with lower conversion loss in mixer circuits. The bond pad for the N-type Schottky diode is the anode.

NEW

Skyworks Green™ products are lead (Pb)-free, RoHS (Restriction of Hazardous Substances)-compliant, conform to the EIA/EICTA/JEITA Joint Industry Guide (JIG) Level A guidelines, and are free from antimony trioxide and brominated flame retardants.

Electrical Specifications at 25 °C

Part Number	Barrier	Junction Type	C_J[1] (pF) Max.	R_T[2] (Ω) Max.	V_F @ 1 mA (mV) Min.–Max.	V_B[3] (V) Min.	R_V @ Zero Bias (kΩ) Typ.	Outline Drawing
CDC7630-000	ZBD	P	0.25	30	135–240	1	5.5	571-006
CDC7631-000	ZBD	P	0.15	80	150–300	2	7.2	571-006
CDB7619-000	Low	P	0.1	40	275–375	2	735	571-006
CDB7620-000	Low	P	0.15	30	250–350	2	537	571-006
CDF7621-000	Low	N	0.1	20	270–350	2	680	571-011
CDF7623-000	Low	N	0.3	10	240–300	2	245	571-011

1. C_J for low barrier diodes specified at 0 V. C_J for ZBDs specified at 0.15 V reverse bias.
2. R_T is the slope resistance at 10 mA. R_S Max. may be calculated from: $R_S = R_T - 2.6 \times N$.
3. V_B for low barrier diodes is specified at 10 µA. V_B for ZBDs is specified at 100 µA.

Typical Performance Data

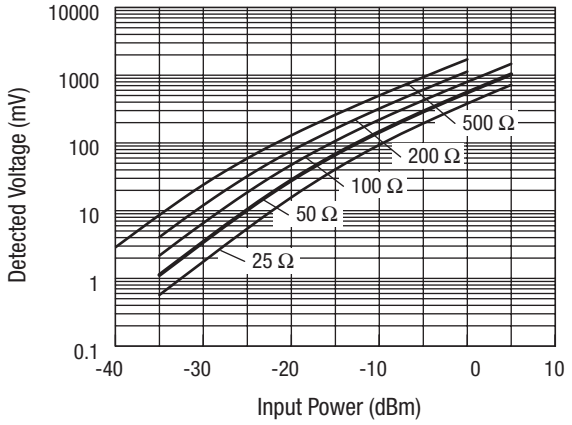
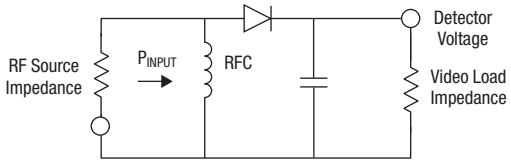
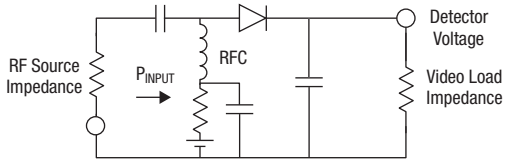


Figure 1. Detected Voltage vs. Input Power and RF Source Impedance



Zero Biased Detector



Biased Detector

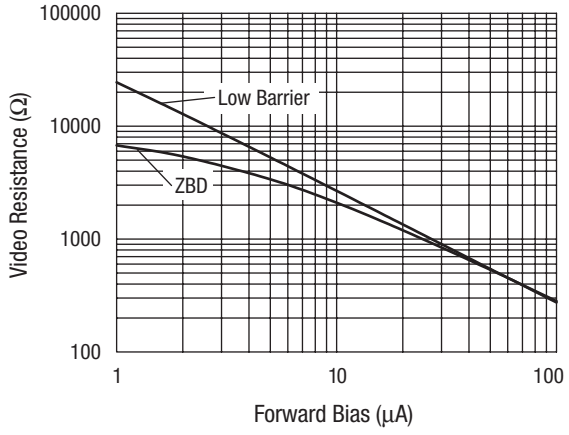


Figure 2. Video Resistance vs. Forward Bias Current

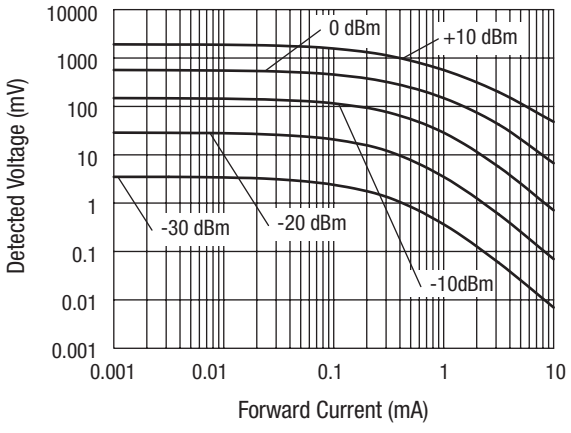


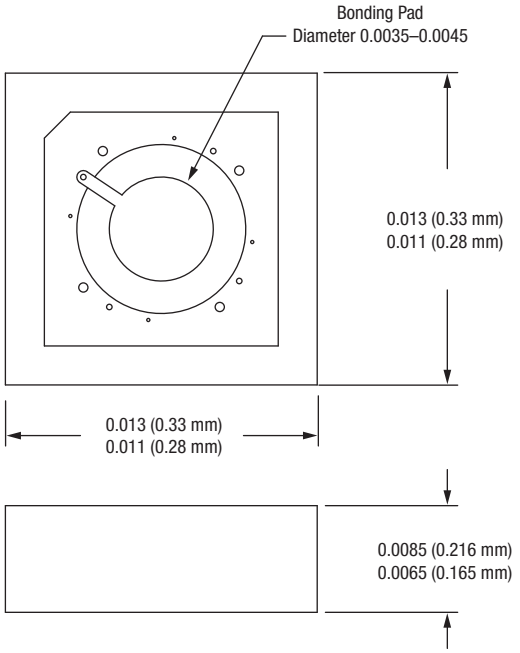
Figure 3. Detected Voltage vs. Forward Current

SPICE Model Parameters

Parameter	CDB7619	CDB7620	CDF7621	CDF7623	CDC7630	CDC7631	Units
IS	3.70E-08	5.40E-08	4.0E-08	1.1E-07	5.0E-06	3.8E-06	A
R_S	9	14	12	6	20	51	Ω
N	1.05	1.12	1.05	1.04	1.05	1.05	
TT	1E-11	1E-11	1E-11	1E-11	1E-11	1E-11	s
C_{J0}	0.08	0.15	0.1	0.22	0.14	0.08	pF
M	0.35	0.35	0.35	0.32	0.4	0.4	
E_G	0.69	0.69	0.69	0.69	0.69	0.69	eV
XTI	2	2	2	2	2	2	
F_C	0.5	0.5	0.5	0.5	0.5	0.5	
B_V	2	4	3	2	2	2	V
I_{BV}	1E-05	1E-05	1E-05	1E-05	1E-04	1E-04	A
V_J	0.495	0.495	0.495	0.495	0.34	0.34	V

Outline Drawing

571-006 (Cathode Bond Pad), 571-011 (Anode Bond Pad)



Absolute Maximum Ratings

Characteristic	Value
Reverse voltage (V_R)	Voltage rating
Forward current (I_F)	50 mA
Power dissipation (P_D)	75 mW
Storage temperature (T_{ST})	-65 °C to +150 °C
Operating temperature (T_{OP})	-65 °C to +150 °C
Electrostatic Discharge (ESD) Human Body Mode (HBM)	Class 0
Electrostatic Discharge (ESD) Charged Device Model (CDM)	Class C4

Performance is guaranteed only under the conditions listed in the specifications table and is not guaranteed under the full range(s) described by the Absolute Maximum specifications. Exceeding any of the absolute maximum/minimum specifications may result in permanent damage to the device and will void the warranty.

CAUTION: *Although this device is designed to be as robust as possible, ESD (Electrostatic Discharge) can damage this device. This device must be protected at all times from ESD. Static charges may easily produce potentials of several kilovolts on the human body or equipment, which can discharge without detection. Industry-standard ESD precautions must be employed at all times.*